Vishay

vPolyTanTM Hermetically Sealed Polymer Surface-Mount Chip Capacitors, Low ESR



LINKS TO ADDITIONAL RESOURCES







PERFORMANCE / ELECTRICAL CHARACTERISTICS

Operating Temperature: -55 °C to +125 °C (above 105 °C, additional voltage derating is required)

Capacitance Range: 15 μ F to 470 μ F Capacitance Tolerance: \pm 20 % Voltage Rating: 16 V_{DC} to 75 V_{DC}

FEATURES

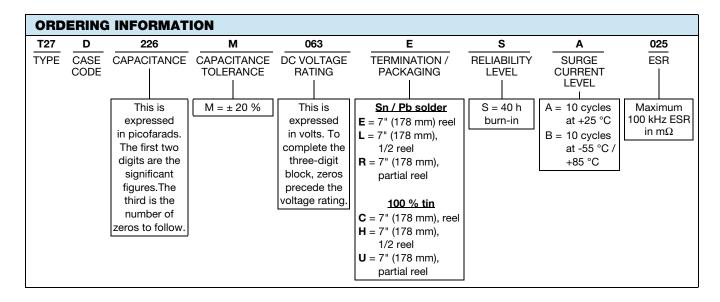
- Ultra low ESR conductive polymer cathode
- Ultra low DC leakage < 0.05 CV
- High reliability processing including:
 - 100 % hermiticity tested metal case
 - 100 % surge current test
 - accelerated voltage conditioning
- thermal shock
- MIL-PRF-39003 style qualification
- · High ripple current capability
- Stable capacitance in operating temperature range
- High frequency capacitance retention
- No wear out effect
- PATENT(S): www.vishay.com/patents
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

Note

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

APPLICATIONS

- Aerospace and hi-rel applications
- Switch mode and point of load power supply

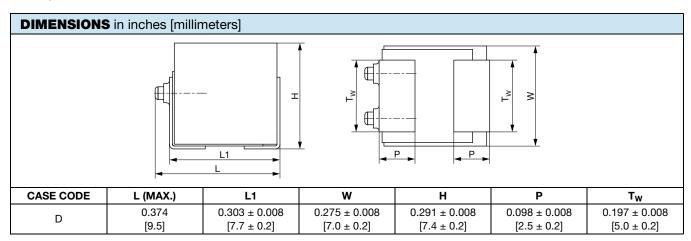


PATENT(S): www.vishay.com/patents

Revision: 14-Jul-2022

This Vishay product is protected by one or more United States and international patents.

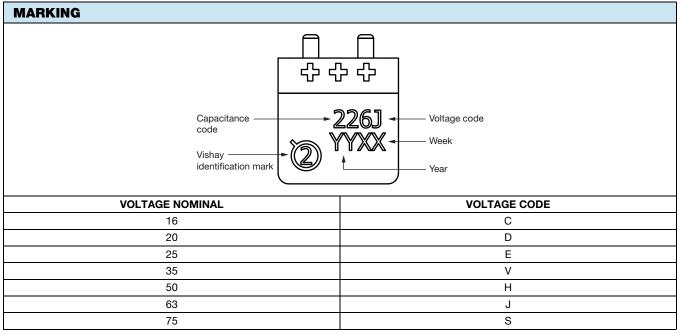




RATINGS AND CASE CODES (ESR, m Ω)						
μF	16 V	25 V	35 V	50 V	63 V	75 V
15					D (100) ⁽¹⁾	D (100) ⁽¹⁾
22				D (100) ⁽¹⁾	D (100) ⁽¹⁾	D (100) ⁽¹⁾
33				D (100) ⁽¹⁾	D (100) ⁽¹⁾	
47			D (70) ⁽¹⁾	D (100)		
150			D (100) ⁽¹⁾			
220		D (55) ⁽¹⁾				
330	D (25)					
470	D (25) ⁽¹⁾					

Note

⁽¹⁾ Currently in development, contact factory for availability



- Marking shows discrete capacitor rating
- · Capacitance code is expressed in picofarads. The first two digits are the significant figures. The third is the number of zeros to follow

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STANDARD RATINGS								
CADACITANCE	CASE		MAX. DCL	MAX. DF	MAX. ESR	MAX. RIPPLE	HIGH TEMPERATURE LOAD	
CAPACITANCE (μF)	CODE	PART NUMBER	AT 25 °C (μΑ)	AT 25 °C 120 Hz (%)	AT +25 °C 100 kHz (mΩ)	100 kHz I _{RMS} (A)	TEMPERATURE (°C)	TIME (h)
		16	V _{DC} AT +105	°C, 10 V _{DC}	AT +125 °C			
330	D	T27D337M016(1)(2)(3)025	264	12	25	4.899	125	2000
470	D ⁽¹⁾	T27D477M016(1)(2)(3)025	376	12	25	4.899	125	2000
		25	V _{DC} AT +105	°C, 20 V _{DC}	AT +125 °C			
220	D (1)	T27D227M025(1)(2)(3)055	275	12	55	3.303	125	2000
		35	V _{DC} AT +105	°C, 25 V _{DC}	AT +125 °C			
47	D ⁽¹⁾	T27D476M035(1)(2)(3)070	82	12	70	2.928	125	2000
150	D ⁽¹⁾	T27D157M035(1)(2)(3)100	263	12	100	2.449	125	2000
		50	V _{DC} AT +105	°C, 33 V _{DC}	AT +125 °C			
22	D (1)	T27D226M050(1)(2)(3)100	55	12	100	2.449	125	2000
33	D ⁽¹⁾	T27D336M050(1)(2)(3)100	83	12	100	2.449	125	2000
47	D	T27D476M050(1)(2)(3)100	118	12	100	2.449	125	2000
		63	V _{DC} AT +105	°C, 43 V _{DC}	AT +125 °C			
15	D (1)	T27D156M063(1)(2)(3)100	47	12	100	2.449	125	2000
22	D (1)	T27D226M063(1)(2)(3)100	69	12	100	2.449	125	2000
33	D (1)	T27D336M063(1)(2)(3)100	104	12	100	2.449	125	2000
		75	V _{DC} AT +105	°C, 50 V _{DC}	AT +125 °C			
15	D ⁽¹⁾	T27D156M075(1)(2)(3)100	56	12	100	2.449	125	2000
22	D (1)	T27D226M075(1)(2)(3)100	83	12	100	2.449	125	2000

Notes

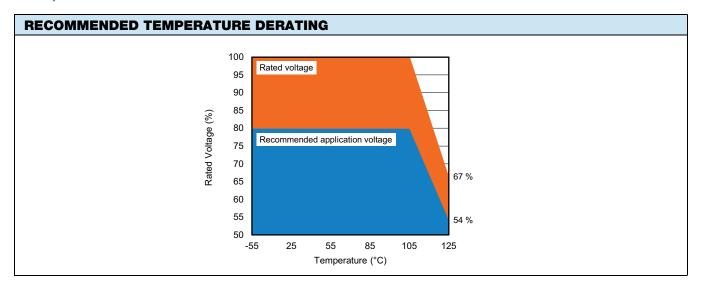
Part number definitions:

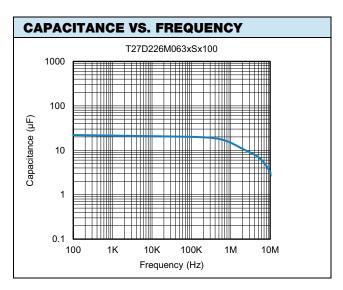
(1) Termination and packaging: E, L, C, H
(2) Reliability level: S
(3) Surge current: A, B

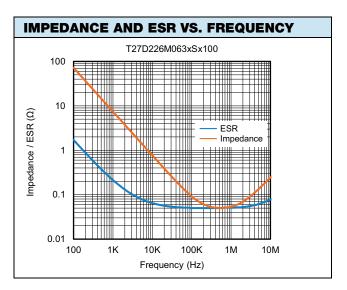
(1) Rating in development, contact factory for availability

RECOMMENDED VOLTAGE DERATING GUIDELINES						
CAPACITOR VOLTAGE RATING AT -55 °C TO +105 °C	CAPACITOR VOLTAGE RATING AT +105 °C TO +125 °C	OPERATING VOLTAGES FOR TEMPERATURES AT -55 °C TO +105 °C	OPERATING VOLTAGES FOR TEMPERATURES AT +105 °C TO +125 °C			
16	10.7	12.8	8.6			
25	16.8	20	13.4			
35	23.5	28	18.8			
50	33.5	40	26.8			
63	42	50.4	33.8			
75	50	60	40			









POWER DISSIPATION						
CASE CODE	MAXIMUM PERMISSIBLE POWER DISSIPATION (W) AT \leq +45 °C IN FREE AIR					
D	0.6					

STANDARD PACKAGING QUANTITY						
CASE CODE 7" FULL REEL 7" HALF REEL						
D 100 50						



GROUP	ITEM	CONDITION		POST TEST PERFORMANCE			
				Capacitance change	Within ± 10 % of initial value		
	Shock (specified pulse)	MIL-STD-202-213, condition 100 g peak	l,	Dissipation factor	Within initial limit		
	(opcomed paide)	100 g peak		Leakage current	Shall not exceed 200 % of initial lim		
				Capacitance change	Within ± 10 % of initial value		
				Dissipation factor	Within initial limit		
	Vibration	MIL-STD-202-204, condition 10 Hz to 2000 Hz, 20 g peak		Leakage current	Shall not exceed 200 % of initial lim		
		-		There shall be no med post-conditioning.	There shall be no mechanical or visual damage to capacitor post-conditioning.		
1	Salt atmosphere (corrosion)	MIL-STD-202-101, condition	В		sually examined for evidence of corrosi vill affect life or serviceability.		
				Capacitance change	Within ± 20 % of initial value		
	Thermal shock	MIL-STD-202-107, condition	В	Dissipation factor	Within initial limit		
				Leakage current	Shall not exceed 200 % of initial lin		
				Capacitance change	Within ± 20 % of initial value		
		MIL-STD-202-104, condition B		Dissipation factor	Within initial limit		
	Immersion			Leakage current	Shall not exceed 200 % of initial lin		
				Capacitors shall be visually examined for evidence of corrosion, mechanical damage, and obliteration of marking			
Resistan	Solderability	MIL-STD-202-208, condition B		After the test, the sold	After the test, the solderable surfaces shall be examined.		
	Resistance to solvents	MIL-STD-202-215			There shall be no evidence of mechanical damage and the marking shall remain legible.		
	Resistance to soldering heat	MIL-STD-202-210, condition J		Capacitance change	Within ± 20 % of initial value		
				Dissipation factor	Within initial limit		
	coldolling float			Leakage current	Shall not exceed 200 % of initial lin		
II				Capacitance change	Within ± 10 % of initial value		
	Maiatoma			Dissipation factor	Within initial limit		
	Moisture resistance	MIL-STD-202-106		Leakage current	Shall not exceed 200 % of initial lin		
				There shall be no evidence of harmful corrosion, mechanica damage, or obliteration of marking.			
	Sleeving	MIL-PRF-39003		The insulation resistance shall be 1000 M Ω , minimum.			
				Capacitance change	Within -20 % to +0 % of initial valu		
			-55 °C	Dissipation factor	Shall not exceed 150 % of initial lin		
				Leakage current	n/a		
				Capacitance change	Within ± 20 % of initial value		
			25 °C	Dissipation factor	Within initial limit		
	Stability at low and high	MIL-PRF-39003		Leakage current	Within initial limit		
	temperatures	WIIL-PHF-39003		Capacitance change	Within -0 % to +30 % of initial value		
Ш			85 °C	Dissipation factor	Shall not exceed 150 % of initial		
				Leakage current	Shall not exceed 1000 % of initial va		
				Capacitance change	Within -0 % to +40 % of initial valu		
			125°C	Dissipation factor	Shall not exceed 200 % of initial		
				Leakage current	Shall not exceed 1250 % of initial I		
				Capacitance change	Within ± 10 % of initial value		
	Surge voltage	MIL-PRF-39003		Dissipation factor	Within initial limit		
	- 0			Leakage current	Shall not exceed 200 % of initial lir		



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PERFORMANCE CHARACTERISTICS: MIL-PRF-39003 STYLE						
GROUP	ITEM	CONDITION	POST TEST PERFORMANCE			
			Capacitance change	Within ± 20 % of initial value		
IV	Life test at +125 °C	2000 h application of 2/3 rated voltage at 125 °C, MIL-STD-202-108	Dissipation factor	Shall not exceed 150 % of initial		
	ut : 120 0		Leakage current	Shall not exceed 125 % of initial limit		
		2000 h application of rated voltage at 85 °C, MIL-STD-202-108	Capacitance change	Within ± 20 % of initial value		
V	Life test at +85 °C		Dissipation factor	Shall not exceed 150 % of initial		
			Leakage current	Shall not exceed 125 % of initial limit		
		Shear test AEC-Q200-006	Capacitance change	Within ± 20 % of initial value		
VI	Shear test		Dissipation factor	Within initial limit		
			Leakage current	Shall not exceed 200 % of initial limit		

PRODUCT INFORMATION					
Polymer Guide	www.vishay.com/doc?40076				
Moisture Sensitivity	www.vishay.com/doc?40135				
Infographic	www.vishay.com/doc?48084				
Sample Board	www.vishay.com/doc?48073				
FAQ					
Frequently Asked Questions	www.vishay.com/doc?42106				



Guide for Tantalum Solid Electrolyte Chip Capacitors With Polymer Cathode

INTRODUCTION

Tantalum electrolytic capacitors are the preferred choice in applications where volumetric efficiency, stable electrical parameters, high reliability, and long service life are primary considerations. The stability and resistance to elevated temperatures of the tantalum/tantalum oxide/manganese dioxide system make solid tantalum capacitors an appropriate choice for today's surface mount assembly technology.

Vishay Sprague has been a pioneer and leader in this field, producing a large variety of tantalum capacitor types for consumer, industrial, automotive, military, and aerospace electronic applications.

Tantalum is not found in its pure state. Rather, it is commonly found in a number of oxide minerals, often in combination with Columbium ore. This combination is known as "tantalite" when its contents are more than one-half tantalum. Important sources of tantalite include Australia, Brazil, Canada, China, and several African countries. Synthetic tantalite concentrates produced from tin slags in Thailand, Malaysia, and Brazil are also a significant raw material for tantalum production.

Electronic applications, and particularly capacitors, consume the largest share of world tantalum production. Other important applications for tantalum include cutting tools (tantalum carbide), high temperature super alloys, chemical processing equipment, medical implants, and military ordnance.

Vishay Sprague is a major user of tantalum materials in the form of powder and wire for capacitor elements and rod and sheet for high temperature vacuum processing.

THE BASICS OF TANTALUM CAPACITORS

Most metals form crystalline oxides which are non-protecting, such as rust on iron or black oxide on copper. A few metals form dense, stable, tightly adhering, electrically insulating oxides. These are the so-called "valve" metals and include titanium, zirconium, niobium, tantalum, hafnium, and aluminum. Only a few of these permit the accurate control of oxide thickness by electrochemical means. Of these, the most valuable for the electronics industry are aluminum and tantalum.

Capacitors are basic to all kinds of electrical equipment, from radios and television sets to missile controls and automobile ignitions. Their function is to store an electrical charge for later use.

Capacitors consist of two conducting surfaces, usually metal plates, whose function is to conduct electricity. They are separated by an insulating material or dielectric. The dielectric used in all tantalum electrolytic capacitors is tantalum pentoxide.

Tantalum pentoxide compound possesses high-dielectric strength and a high-dielectric constant. As capacitors are being manufactured, a film of tantalum pentoxide is applied to their electrodes by means of an electrolytic process. The film is applied in various thicknesses and at various voltages and although transparent to begin with, it takes on different colors as light refracts through it. This coloring occurs on the tantalum electrodes of all types of tantalum capacitors.

Rating for rating, tantalum capacitors tend to have as much as three times better capacitance/volume efficiency than aluminum electrolytic capacitors. An approximation of the capacitance/volume efficiency of other types of capacitors may be inferred from the following table, which shows the dielectric constant ranges of the various materials used in each type. Note that tantalum pentoxide has a dielectric constant of 26, some three times greater than that of aluminum oxide. This, in addition to the fact that extremely thin films can be deposited during the electrolytic process mentioned earlier, makes the tantalum capacitor extremely efficient with respect to the number of microfarads available per unit volume. The capacitance of any capacitor is determined by the surface area of the two conducting plates, the distance between the plates, and the dielectric constant of the insulating material between the plates.

COMPARISON OF CAPACITOR DIELECTRIC CONSTANTS				
DIELECTRIC	e DIELECTRIC CONSTANT			
Air or vacuum	1.0			
Paper	2.0 to 6.0			
Plastic	2.1 to 6.0			
Mineral oil	2.2 to 2.3			
Silicone oil	2.7 to 2.8			
Quartz	3.8 to 4.4			
Glass	4.8 to 8.0			
Porcelain	5.1 to 5.9			
Mica	5.4 to 8.7			
Aluminum oxide	8.4			
Tantalum pentoxide	26			
Ceramic	12 to 400K			

In the tantalum electrolytic capacitor, the distance between the plates is very small since it is only the thickness of the tantalum pentoxide film. As the dielectric constant of the tantalum pentoxide is high, the capacitance of a tantalum capacitor is high if the area of the plates is large:

$$C = \frac{eA}{t}$$

where

C = capacitance

e = dielectric constant

A = surface area of the dielectric

t = thickness of the dielectric

Tantalum capacitors contain either liquid or solid electrolytes. In solid electrolyte capacitors, a dry material (manganese dioxide) forms the cathode plate. A tantalum lead is embedded in or welded to the pellet, which is in turn connected to a termination or lead wire. The drawings show the construction details of the surface mount types of tantalum capacitors shown in this catalog.

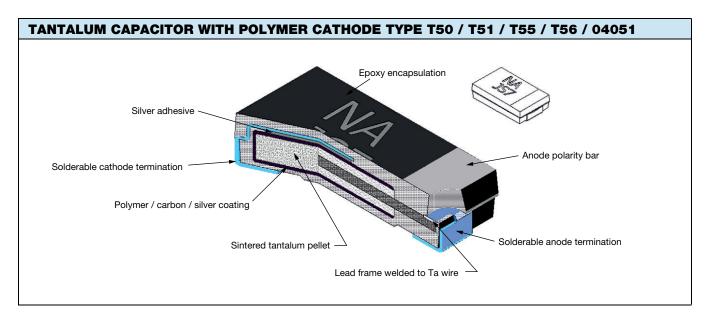


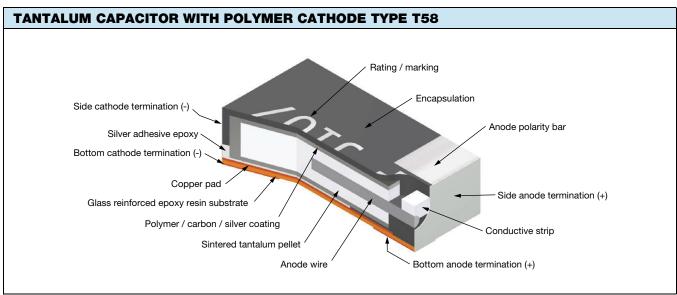
SOLID ELECTROLYTE POLYMER TANTALUM CAPACITORS

Solid electrolyte polymer capacitors utilize sintered tantalum pellets as anodes. Tantalum pentoxide dielectric layer is formed on the entire surface of anode, which is further impregnated with highly conductive polymer as cathode system.

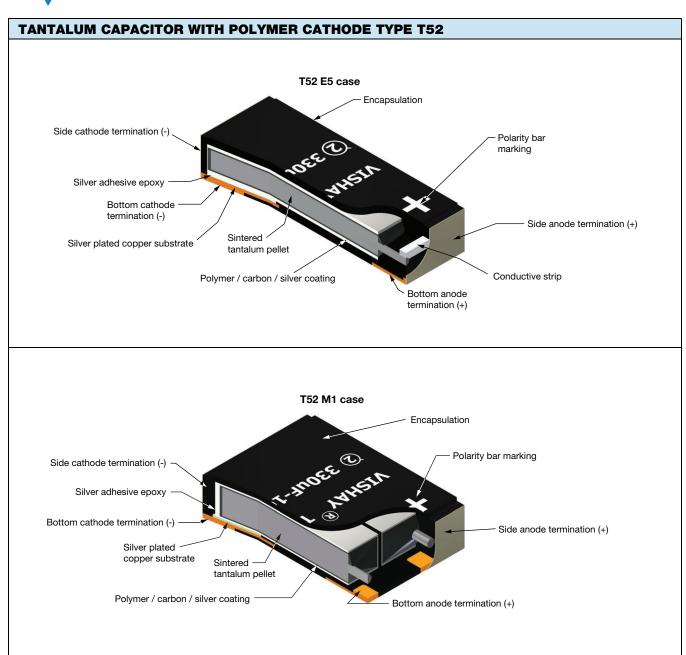
The conductive polymer layer is then coated with graphite, followed by a layer of metallic silver, which provides a conductive surface between the capacitor element and the outer termination (lead frame or other).

Molded chip polymer tantalum capacitor encases the element in plastic resins, such as epoxy materials. The molding compound has been selected to meet the requirements of UL 94 V-0 and outgassing requirements of ASTM E-595. After assembly, the capacitors are tested and inspected to assure long life and reliability. It offers excellent reliability and high stability for variety of applications in electronic devices. Usage of conductive polymer cathode system provides very low equivalent series resistance (ESR), which makes the capacitors particularly suitable for high frequency applications.



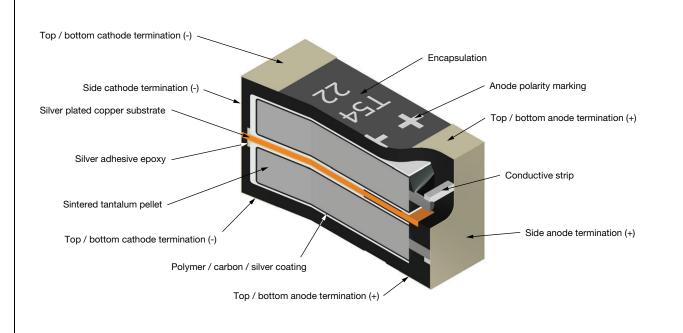


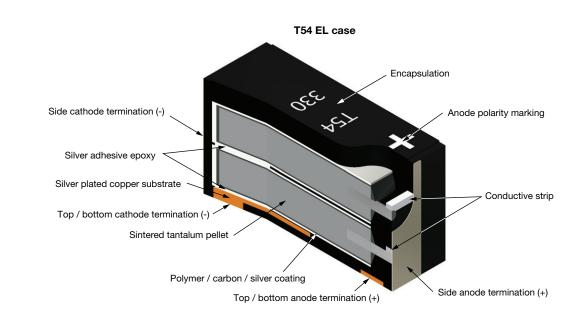




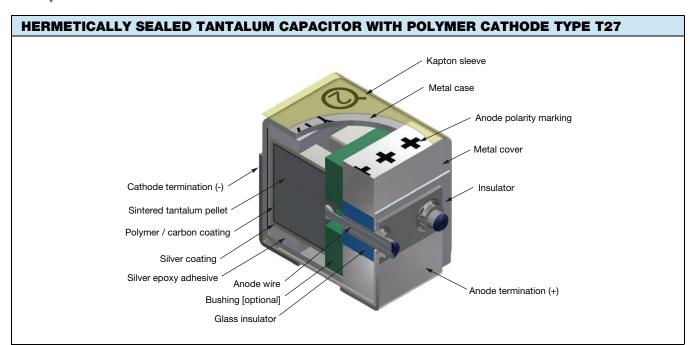


TANTALUM CAPACITOR WITH POLYMER CATHODE TYPE T54 / T59 / 20021









POLYMER CAPACITORS - METAL CASE, HERMETICALLY SEALED					
SERIES	Т27				
PRODUCT IMAGE					
ТҮРЕ	VPolyTan TM hermetically sealed polymer surface-mount chip capacitors, low ESR				
FEATURES	Hermetically sealed in metal case, low ESR / low DCL, hi-rel. processing				
TEMPERATURE RANGE	-55 °C to +125 °C				
CAPACITANCE RANGE	15 μF to 470 μF				
VOLTAGE RANGE	16 V to 75 V				
CAPACITANCE TOLERANCE	± 20 %				
LEAKAGE CURRENT	0.05 CV				
DISSIPATION FACTOR	12 %				
ESR	25 m Ω to 100 m Ω				
CASE SIZES	D				
TERMINATION FINISH	100 % tin; tin / lead				

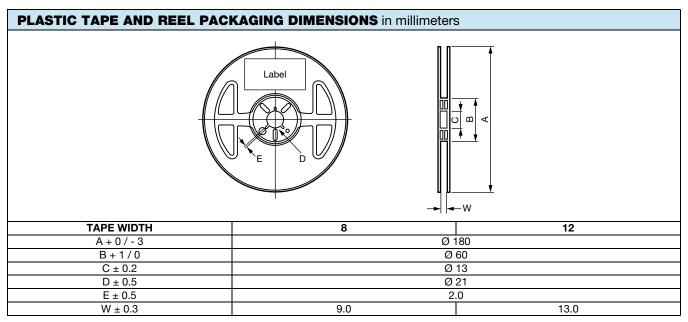


POLYMER CAPACITORS - MOLDED CASE							
SERIES	T50, T51, T55, T56	04051					
PRODUCT IMAGE	THE REAL PROPERTY OF THE PARTY	AND RESERVED THE STATE OF THE S					
TYPE	VPolyTan TM , molded case, high performance polymer	VPolyTan [™] , molded case, high performance polymer					
FEATURES	High performance	High performance					
TEMPERATURE RANGE	-55 °C to +105 °C / +125 °C	-55 °C to +125 °C (above +105 °C, voltage derating is required)					
CAPACITANCE RANGE	3.3 μF to 1000 μF	4.7 μF to 680 μF					
VOLTAGE RANGE	2.5 V to 63 V	2.5 V to 63 V					
CAPACITANCE TOLERANCE	± 20 %	± 10 %, ± 20 %					
LEAKAGE CURRENT	0.1 CV	0.1 CV					
DISSIPATION FACTOR	8 % to 10 %	8 % to 10 %					
ESR	6 m Ω to 500 m Ω	25 m Ω to 125 m Ω					
CASE SIZES	J, P, A, T, B, Z, V, D, C	B, D					
TERMINATION FINISH	Cases J, P, C: 100 % tin Case A, T, B, Z, V, D: Ni / Pd / Au	All cases: tin / lead (SnPb)					

POLYMER CAPACITORS - LEADFRAMELESS MOLDED CASE							
SERIES	T52	T58	T59	T54	20021		
PRODUCT IMAGE		# NOT					
ТҮРЕ	vPolyTan TM polymer surface mount chip capacitors, low profile, leadframeless molded type	vPolyTan TM polymer surface mount chip capacitors, compact, leadframeless molded type	vPolyTan TM polymer surface mount chip capacitors, low ESR, leadframeless molded type	vPolyTan TM polymer surface mount chip capacitors, low ESR, leadframeless molded type, hi-rel commercial off-the-shelf (COTS)	vPolyTan TM polymer surface mount chip capacitors, low ESR, leadframeless molded type, DLA approved		
FEATURES	Low profile	Small case size	Multianode	Hi-rel COTS, multianode	Multianode		
TEMPERATURE RANGE	-55 °C to +105 °C	-55 °C to +105 °C	-55 °C to +125 °C	-55 °C to +125 °C	-55 °C to +125 °C		
CAPACITANCE RANGE	47 μF to 470 μF	1 μF to 100 μF	15 μF to 470 μF	15 µF to 470 µF (discrete capacitors) 30 µF to 2800 µF (stacked capacitors)	15 µF to 470 µF (discrete capacitors) 30 µF to 2800 µF (stacked capacitors)		
VOLTAGE RANGE	10 V to 35 V	6.3 V to 35 V	16 V to 75 V	16 V to 75 V	16 V to 75 V		
CAPACITANCE TOLERANCE	± 20 %	± 20 %	± 10 %, ± 20 %	± 20 %	± 20 %		
LEAKAGE CURRENT	0.1 CV						
DISSIPATION FACTOR	10 %	8 % to 14 %	10 % to 12 %	10 % to 12 %	10 % to 12 %		
ESR	40 m Ω to 200 m Ω	90 m Ω to 500 m Ω	20 m Ω to 150 m Ω	5 m Ω to 150 m Ω	5 m Ω to 150 m Ω		
CASE SIZES	E5, M1, M9, B2	MM, W0, W9, A0, BB	EE, EL	EE, EL, E2, E3, E4, E6, 3E, 6E	EE, E2, E3, E4, E6, 3E, 6E		
TERMINATION	100	% tin	100 % tin	; tin / lead	Tin / lead		

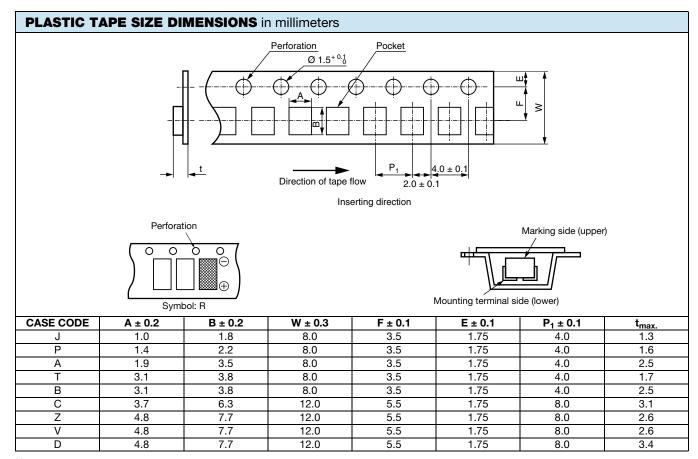


MOLDED CAPACITORS, T50 / T51 / T55 / T56 / 04051 TYPES



Note

· A reel diameter of 330 mm is also applicable

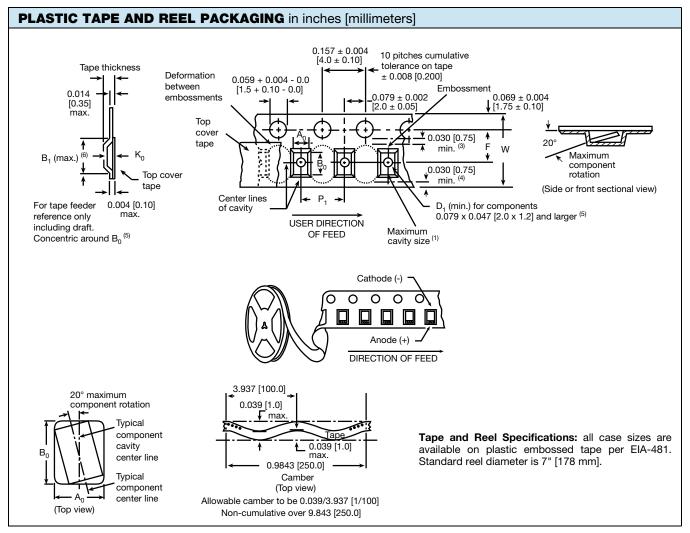


Note

A reel diameter of 330 mm is also applicable



LEADFRAMELESS MOLDED CAPACITORS, ALL TYPES



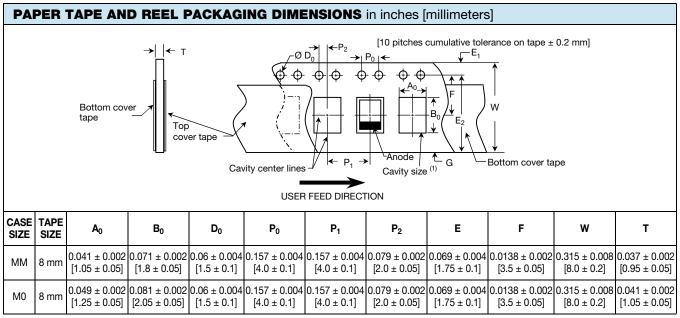
- Metric dimensions will govern. Dimensions in inches are rounded and for reference only
- (1) A₀, B₀, K₀, are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀, K₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°
- (2) Tape with components shall pass around radius "R" without damage. The minimum trailer length may require additional length to provide "R" minimum for 12 mm embossed tape for reels with hub diameters approaching N minimum
- (3) This dimension is the flat area from the edge of the sprocket hole to either outward deformation of the carrier tape between the embossed cavities or to the edge of the cavity whichever is less
- (4) This dimension is the flat area from the edge of the carrier tape opposite the sprocket holes to either the outward deformation of the carrier tape between the embossed cavity or to the edge of the cavity whichever is less
- (5) The embossed hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location shall be applied independent of each other
- (6) B₁ dimension is a reference dimension tape feeder clearance only



CARRIER TAPE DIMENSIONS in inches [millimeters]								
CASE CODE	TAPE SIZE	B ₁ (MAX.) ⁽¹⁾	D ₁ (MIN.)	F	K ₀ (MAX.)	P ₁	P ₂	w
E5	12 mm	0.329 [8.35]	0.059 [1.5]	0.217 ± 0.002 [5.50 ± 0.05]	0.071 [1.8]	0.315 ± 0.004 [8.0 ± 0.10]	0.079 ± 0.002 [2.00 ± 0.05]	0.476 ± 0.008 [12.1 ± 0.20]
MM ⁽²⁾	8 mm	0.075 [1.91]	0.02 [0.5]	0.138 [3.5]	0.043 [1.10]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
M1, M9	12 mm	0.32 [8.2]	0.059 [1.5]	0.217 ± 0.002 [5.5 ± 0.05]	0.094 [2.39]	0.315 ± 0.04 [8.0 ± 1.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10]
W9	8 mm	0.126 [3.20]	0.030 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
WO	8 mm	0.126 [3.20]	0.030 [0.75]	0.138 [3.5]	0.045 [1.15]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
A0	8 mm	1	0.02 [0.5]	0.138 [3.5]	0.049 [1.25]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
ВВ	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.087 [2.22]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
EE, EL	12 mm	0.32 [8.2]	0.059 [1.5]	0.217 ± 0.002 [5.5 ± 0.05]	0.175 [4.44]	0.315 ± 0.04 [8.0 ±1.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.472 + 0.012 / - 0.004 [12.0 + 0.3 / - 0.10]
B2	8 mm	0.157 [4.0]	0.039 [1.0]	0.138 [3.5]	0.057 [1.45]	0.157 [4.0]	0.079 ± 0.002 [2.00 ± 0.05]	0.315 [8.0]
D (3)	16 mm	0.321 [8.16]	0.059 [1.5]	0.295 ± 0.004 [7.50 ± 0.1]	0.308 [7.83]	0.472 ± 0.004 [12.00 ± 0.1]	0.079 ± 0.004 [2.00 ± 0.1]	0.630 ± 0.012 [16.00 ± 0.3]

Notes

- (1) For reference only
- (2) Standard packaging of MM case is with paper tape. Plastic tape is available per request
- (3) Tape thickness 0.018 [0.45] max.



Note

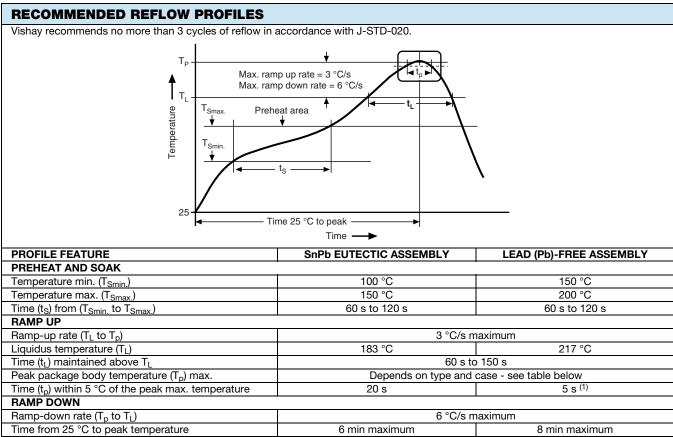
⁽¹⁾ A₀, B₀ are determined by the maximum dimensions to the ends of the terminals extending from the component body and / or the body dimensions of the component. The clearance between the ends of the terminals or body of the component to the sides and depth of the cavity (A₀, B₀) must be within 0.002" (0.05 mm) minimum and 0.020" (0.50 mm) maximum. The clearance allowed must also prevent rotation of the component within the cavity of not more than 20°



PACKING AND STORAGE

Polymer capacitors meet moisture sensitivity level rating (MSL) of 3 or 4 as specified in IPC/JEDEC® J-STD-020 and are dry packaged in moisture barrier bags (MBB) per J-STD-033. MSL for each particular family is defined in the datasheet - either in "Features" section or "Standard Ratings" table. Level 3 specifies a floor life (out of bag) of 168 hours and level 4 specifies a floor life of 72 hours at 30 °C maximum and 60 % relative humidity (RH). Unused capacitors should be re-sealed in the MBB with fresh desiccant. A moisture strip (humidity indicator card) is included in the bag to assure dryness. To remove excess moisture, capacitors can be dried at 40 °C (standard "dry box" conditions).

For detailed recommendations please refer to J-STD-033.



Note

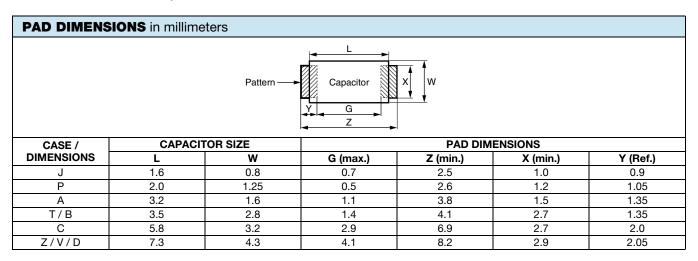
⁽¹⁾ For T27, lead (Pb)-free capacitors $t_p = 30 \text{ s}$

PEAK PACKAGE BODY TEMPERATURE (Tp) MAXIMUM							
TYPE	CASE CODE	PEAK PACKAGE BODY TEMPERATURE (T _P) MAX.					
ITPE	CASE CODE	SnPb EUTECTIC ASSEMBLY	LEAD (Pb)-FREE ASSEMBLY				
T27	D	220 °C	245 °C				
T55	J, P, A, T, B, C, Z, V, D		260 °C				
T52	E5, M1, M9, B2	n/a	260 °C				
T58	MM, W9, W0, A0, BB		260 °C				
T50	D		260 °C				
T51	D, V		260 °C				
T56	B, D, V		250 °C				
T59	EE, EL	220 °C	250 °C				
T54	EL, 3E, 6E, EE, E2, E3, E4, E6	220 °C	250 °C				
20021	3E, 6E, EE, E2, E3, E4, E6	220 °C	n/a				
04051	B, D	220 °C	n/a				

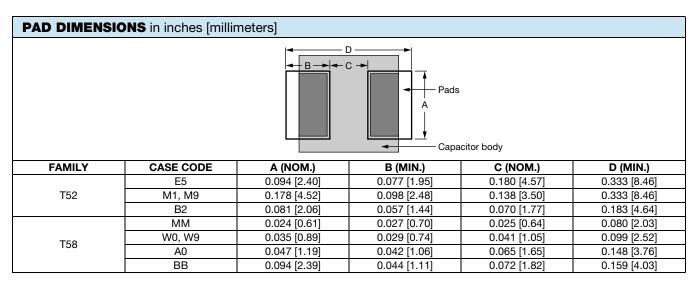
- T50, T51, T52, T55, T56, and T58 capacitors are process sensitive. PSL classification to JEDEC J-STD-075: R4G
- T54 and T59 capacitors with 100 % tin termination are process sensitive.
 PSL classification to JEDEC J-STD-075: R6G



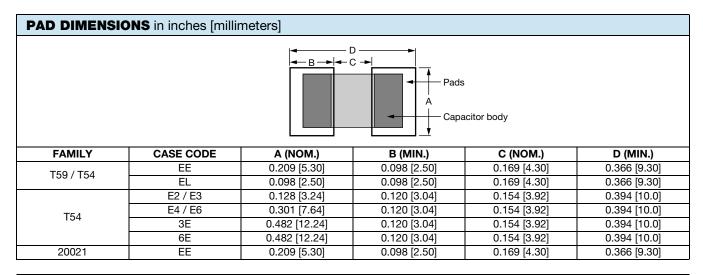
MOLDED CAPACITORS, T50 / T51 / T55 / T56 / 04051 TYPES



LEADFRAMELESS MOLDED CAPACITORS T52 / T58

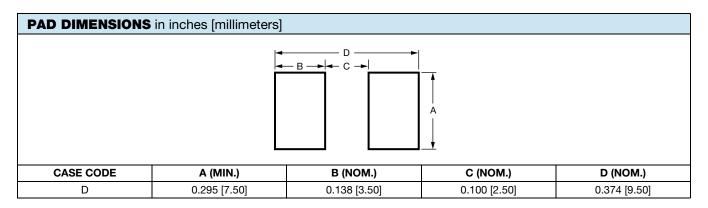


LEADFRAMELESS MOLDED CAPACITORS T59 / T54 / 20021



Revision: 22-Nov-2023 11 Document Number: 40076

HERMETICALLY SEALED CAPACITOR T27 TYPE



GUIDE TO APPLICATION

 AC Ripple Current: the maximum allowable ripple current shall be determined from the formula:

$$I_{RMS} = \sqrt{\frac{P}{R_{ESR}}}$$

where,

P = power dissipation in W at +45 °C as given in the tables in the product datasheets.

R_{ESR} = the capacitor equivalent series resistance at the specified frequency.

 AC Ripple Voltage: the maximum allowable ripple voltage shall be determined from the formula:

$$V_{\text{RMS}} \, = \, Z \sqrt{\frac{P}{R_{\text{ESR}}}}$$

or, from the formula:

$$V_{RMS} = I_{RMS} \times Z$$

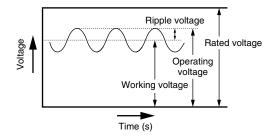
where,

P = power dissipation in W at +45 °C as given in the tables in the product datasheets.

R_{ESR} = The capacitor equivalent series resistance at the specified frequency.

Z = The capacitor impedance at the specified frequency.

2.1 The tantalum capacitors must be used in such a condition that the sum of the working voltage and ripple voltage peak values does not exceed the rated voltage as shown in figure below.



3. **Temperature Derating:** power dissipation is affected by the heat sinking capability of the mounting surface. If these capacitors are to be operated at temperatures above +45 °C, the permissible ripple current (or voltage) shall be calculated using the derating coefficient as shown in the table below:

MAXIMUM RIPPLE CURRENT TEMPERATURE DERATING FACTOR				
≤ 45 °C	1.0			
55 °C	0.8			
85 °C	0.6			
105 °C	0.4			
125 °C	0.25			

 Reverse Voltage: the capacitors are not intended for use with reverse voltage applied. However, they are capable of withstanding momentary reverse voltage peaks, which must not exceed the following values:

At 25 $^{\circ}\text{C}$: 10 % of the rated voltage or 1 V, whichever is smaller.

At 85 $^{\circ}\text{C}$: 5 % of the rated voltage or 0.5 V, whichever is smaller.

At 105 °C: 3 % of the rated voltage or 0.3 V, whichever is smaller.

5. **Mounting Precautions:**

5.1 **Soldering:** capacitors can be attached by conventional soldering techniques; vapor phase, convection reflow, infrared reflow, wave soldering, and hot plate methods. The soldering profile charts show recommended time / temperature conditions for soldering. Preheating is recommended. The recommended maximum ramp rate is 3 °C per second. Attachment with a soldering iron is not recommended due to the difficulty of controlling temperature and time at temperature. The soldering iron must never come in contact with the capacitor. For details see www.vishay.com/doc?40214.

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www.vishay.com

5.2 Limit Pressure on Capacitor Installation with Mounter: pressure must not exceed 4.9 N with a tool end diameter of 1.5 mm when applied to the capacitors using an absorber, centering tweezers, or similar (maximum permitted pressurization time: 5 s). An excessively low absorber setting position would result in not only the application of undue force to the capacitors but capacitor and other component scattering, circuit board wiring breakage, and / or cracking as well, particularly when the capacitors are mounted together with other chips having a height of 1 mm or less.

5.3 Flux Selection

- 5.3.1 Select a flux that contains a minimum of chlorine and amine.
- 5.3.2 After flux use, the chlorine and amine in the flux remain must be removed.
- 5.4 **Cleaning After Mounting:** the following solvents are usable when cleaning the capacitors after mounting. Never use a highly active solvent.
 - Halogen organic solvent (HCFC225, etc.)
 - Alcoholic solvent (IPA, ethanol, etc.)
 - Petroleum solvent, alkali saponifying agent, water, etc.

Circuit board cleaning must be conducted at a temperature of not higher than 50 °C and for an immersion time of not longer than 30 minutes. When an ultrasonic cleaning method is used, cleaning must be conducted at a frequency of 48 kHz or lower, at an vibrator output of 0.02 W/cm³, at a temperature of not higher than 40 °C, and for a time of 5 minutes or shorter.

- Care must be exercised in cleaning process so that the mounted capacitor will not come into contact with any cleaned object or the like or will not get rubbed by a stiff brush or similar. If such precautions are not taken particularly when the ultrasonic cleaning method is employed, terminal breakage may occur
- When performing ultrasonic cleaning under conditions other than stated above, conduct adequate advance checkout



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